

# **General Description**

The WST2303 is the highest performance trench P-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2303 meet the RoHS and Green Product requirement with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

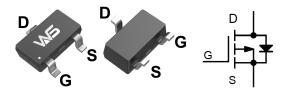
#### **Product Summery**

BVDSS	RDSON	ID		
-20V	65mΩ	-3.8A		

#### Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

#### SOT-23-3L Pin Configuration



### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	-20	V	
V <sub>GS</sub>	Gate-Source Voltage	±8	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-3.8	A	
I <sub>D</sub> @T <sub>C</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-2.5	А	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-13	A	
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation <sup>3</sup>	1	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>eja</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		125	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		80	°C/W



P-Ch MOSFET

# Electrical Characteristics (T<sub>J</sub>=25 $^{\circ}$ C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , I <sub>D</sub> =-250uA	-20			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$ , I_D=-1mA		-0.014		V/℃
	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-3A		65	80	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-2A		80	100	
		V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-1.5A		105	130	
V <sub>GS(th)</sub>	Gate Threshold Voltage		-0.3	-0.5	-1.0	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$-V_{GS}=V_{DS}$ , I <sub>D</sub> =-250uA		2.3		mV/℃
	Drain-Source Leakage Current	V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	
I <sub>DSS</sub>		V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			-5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 8V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A		12.2		S
Qg	Total Gate Charge (-4.5V)	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-3A		10.1	14.1	
Q <sub>gs</sub>	Gate-Source Charge			1.21	1.7	nC
Q <sub>gd</sub>	Gate-Drain Charge			2.46	3.4	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =-10V , V <sub>GS</sub> =-4.5V , R <sub>G</sub> =3.3Ω I <sub>D</sub> =-3A		5.6	11.2	
	Rise Time			32.2	58	
T <sub>d(off)</sub>	Turn-Off Delay Time			45.6	91	ns -
T <sub>f</sub>	Fall Time			29.2	58.4	
Ciss	Input Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		677	948	
C <sub>oss</sub>	Output Capacitance			82	115	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			73	102	1

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,4</sup>				-1	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	$V_G=V_D=0V$ , Force Current			-13	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =-1A , $T_{J}$ =25 $^{\circ}$ C			-1	V
t <sub>rr</sub>	Reverse Recovery Time			29		nS
Q <sub>rr</sub>	Reverse Recovery Charge	l͡⊧=-3A , dl/dt=100A/µs , TJ=25℃		8		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

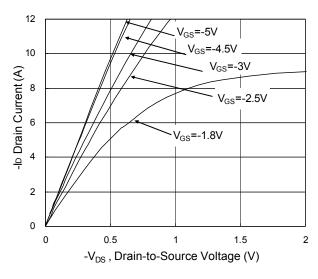
3.The power dissipation is limited by 150  $^{\circ}\mathrm{C}$  junction temperature

4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



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# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

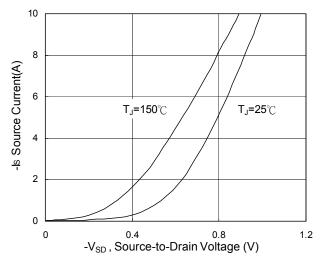


Fig.3 Forward Characteristics Of Reverse

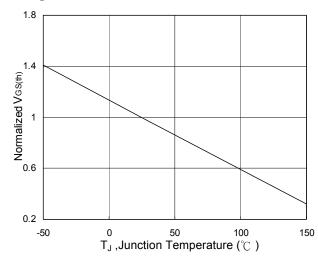


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

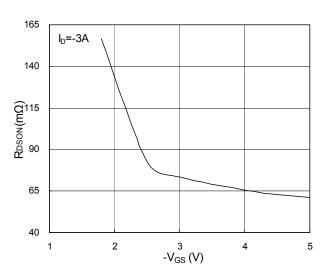


Fig.2 On-Resistance vs. Gate-Source

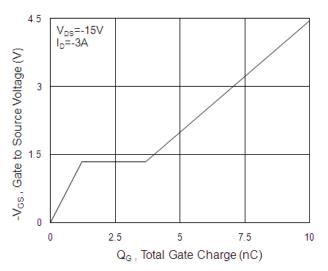


Fig.4 Gate-Charge Characteristics

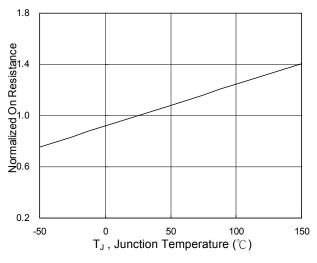


Fig.6 Normalized  $R_{\text{DSON}}$  vs.  $T_{\text{J}}$ 



# P-Ch MOSFET

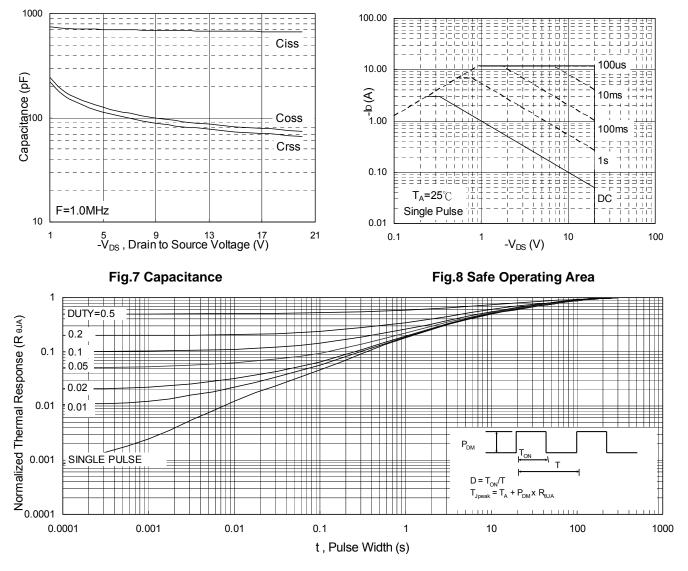
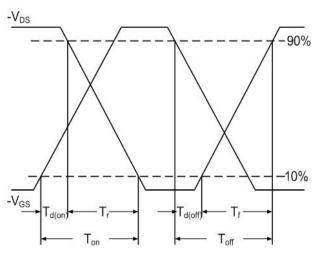
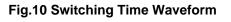
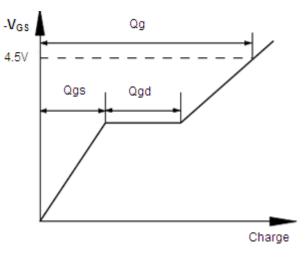


Fig.9 Normalized Maximum Transient Thermal Impedance







### Fig.11 Gate Charge Waveform



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